



## UNITED STATES PATENT AND TRADEMARK OFFICE

UNITED STATES DEPARTMENT OF COMMERCE  
 United States Patent and Trademark Office  
 Address: COMMISSIONER FOR PATENTS  
 P.O. Box 1450  
 Alexandria, Virginia 22313-1450  
[www.uspto.gov](http://www.uspto.gov)



CONFIRMATION NO. 6057

Bib Data Sheet

SERIAL NUMBER 10/666,742	FILING DATE 09/19/2003  RULE	CLASS 438	GROUP ART UNIT 2812	ATTORNEY DOCKET NO. 2269-6095US (03- 0593.00/U)
-----------------------------	---------------------------------------	--------------	------------------------	--

## APPLICANTS

Alan G. Wood, Boise, ID;

Warren M. Farnworth, Nampa, ID;

David R. Hembree, Boise, ID; Sidney B. Rigg, Meridian, ID;

William M. Hiatt, Eagle, ID;

Peter Benson, Boise, ID;

Kyle K. Kirby, Boise, ID;

Salman Akram, Boise, ID;

## \*\* CONTINUING DATA \*\*\*\*\*

*none, of*

## \*\* FOREIGN APPLICATIONS \*\*\*\*\*

*none, of*

## IF REQUIRED, FOREIGN FILING LICENSE GRANTED

\*\* 12/12/2003

Foreign Priority claimed	<input type="checkbox"/> yes <input checked="" type="checkbox"/> no	STATE OR COUNTRY ID	SHEETS DRAWING 10	TOTAL CLAIMS 69	INDEPENDENT CLAIMS 5
35 USC 119 (a-d) conditions met	<input type="checkbox"/> yes <input checked="" type="checkbox"/> no <input type="checkbox"/> Met after <i>Allowance</i>				
Verified and Acknowledged	<i>Douglas Luk</i> Examiner's Signature	Initials			

## ADDRESS

24247  
 TRASK BRITT  
 P.O. BOX 2550  
 SALT LAKE CITY , UT  
 84110

## TITLE

Support structure for thinning semiconductor substrates and thinning methods employing the support structure

<input type="checkbox"/> All Fees
<input type="checkbox"/> 1.16 Fees ( Filing )

FILING FEE  RECEIVED 1954	<p>FEES: Authority has been given in Paper No. _____ to charge/credit DEPOSIT ACCOUNT No. _____ for following:</p>	<input type="checkbox"/> 1.17 Fees ( Processing Ext. of time ) <input type="checkbox"/> 1.18 Fees ( Issue ) <input type="checkbox"/> Other _____ <input type="checkbox"/> Credit
------------------------------------	--	---